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**MAR 02 2004**

**In the United States Patent and Trademark Office**

**OFFICIAL**

In re: Kub et al  
Serial No.: 10/022,364 (NC 79,684)  
Filed: December 20, 2001  
For: Method For Transferring Thin Film Layer Material  
To a Flexible Substrate Using a Hydrogen Splitting  
Technique

Examiner: George Fourson  
Art Unit: 2823

March 2, 2004

**Amendment After Final Rejection**

Honorable Commissioner of Patents and Trademarks  
Washington, D.C. 20230

Sir:

In response to the final rejection dated Oct. 3, 2003, please amend the above-identified  
as follows:

Amendments to the Specification begin on p. 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on p. 5 of this  
paper.

Remarks/Arguments begin on p. 11 of this paper.